

F2

28X **b** 

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0.10 M C A B

0.05 M C NOTE 3

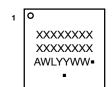
**DATE 25 NOV 2015** 

## NOTES:

- DIMENSIONS AND TOLERANCING PER
   ASME VIA EM 1991
- ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. DIMENSION b APPLIES TO PLATED
  TERMINAL AND IS MEASURED BETWEEN
  0.15 AND 0.30MM FROM THE TERMINAL TI
- 0.15 AND 0.30MM FROM THE TERMINAL TIP. 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.80	1.00	
A1	0.00	0.05	
A3	0.20 REF		
b	0.20	0.30	
D	5.00 BSC		
D2	3.40	3.50	
E	5.00 BSC		
E2	3.40	3.50	
е	0.50 BSC		
L	0.44	0.54	
L1	i	0.15	

## GENERIC MARKING DIAGRAM\*



XXXXX = Specific Device Code

A = Assembly Location

WL = Wafer Lot
YY = Year
WW = Work Week
Pb-Free Package

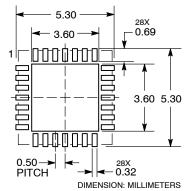
\*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

## RECOMMENDED SOLDERING FOOTPRINT\*

**BOTTOM VIEW** 

<u>aambaaa</u>



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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